## 1. General description

Low leakage current Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- Low forward voltage
- Low leakage current
- · High thermal stability and large Safe Operation Area
- High power capability due to clip-bonding technology
- Small and flat lead SMD plastic package

## 3. Applications

- · High efficiency DC-to-DC conversion
- LED lighting
- · Switch mode power supply
- · Freewheeling application
- · Reverse polarity protection
- OR-ing

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>amb</sub> $\leq$ 168 °C		-	-	10	Α
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	100	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	770	850	mV
I <sub>R</sub>	reverse current	$V_R = 100 \text{ V}$ ; pulsed; $T_j = 25 ^{\circ}\text{C}$	[1]	-	0.2	0.8	μΑ
		V <sub>R</sub> = 100 V; pulsed; T <sub>j</sub> = 125 °C	[1]	-	0.4	2.5	mA

<sup>[1]</sup> Very short pulse, in order to maintain a stable junction temperature.



# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode	5	
2	А	anode		K A
3	K	cathode	2	aaa-009063
			CFP15B (SOT1289B)	

## 6. Ordering information

### **Table 3. Ordering information**

Type number	Package						
	Name	Description	Version				
PMEG100V100ELPE		plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	SOT1289B				

## 7. Marking

### Table 4. Marking codes

Type number	Marking code
PMEG100V100ELPE	100V
	L10E

# 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	100	V
I <sub>F</sub>	forward current	δ = 1; T <sub>sp</sub> ≤ 167 °C		-	14	А
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 168 °C		-	10	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8.3 ms; square wave; $T_{j(init)}$ = 25 °C		-	210	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

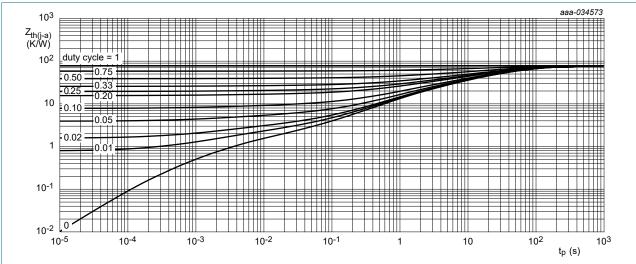
Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

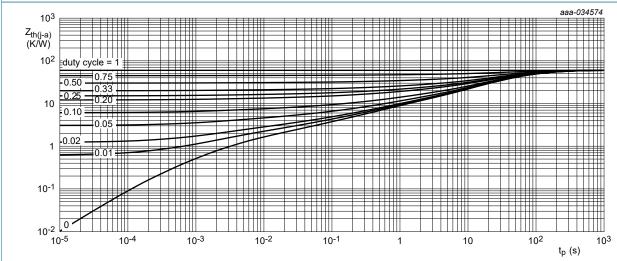
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1] [2]	-	-	90	K/W
ju	junction to ambient		[1] [3]	-	-	70	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[4]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

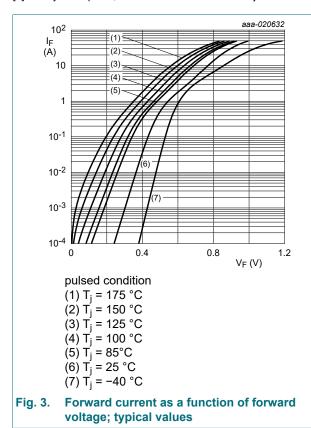
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

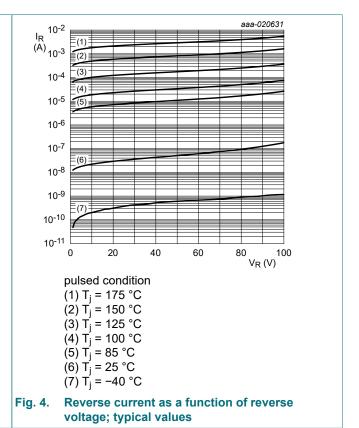
### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>(BR)R</sub>	reverse breakdown voltage	$I_R$ = 1 mA; pulsed; $T_j$ = 25 °C		100	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	545	650	mV
		I <sub>F</sub> = 5 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	700	790	mV
		I <sub>F</sub> = 10 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	770	850	mV
		I <sub>F</sub> = 10 A; pulsed; T <sub>j</sub> = -40 °C	[1]	-	870	960	mV
		I <sub>F</sub> = 10 A; pulsed; T <sub>j</sub> = 125 °C	[1]	-	635	730	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 100 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	0.2	0.8	μΑ
		V <sub>R</sub> = 100 V; pulsed; T <sub>j</sub> = 125 °C	[1]	-	0.4	2.5	mA
		V <sub>R</sub> = 100 V; pulsed; T <sub>j</sub> = 150 °C	[1]	-	1.5	7.5	mA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	276	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	115	-	pF
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$		-	11	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	510	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.





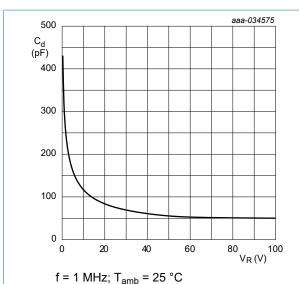
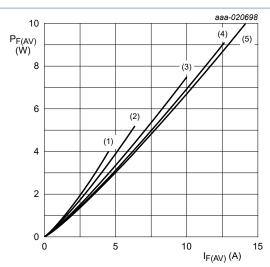
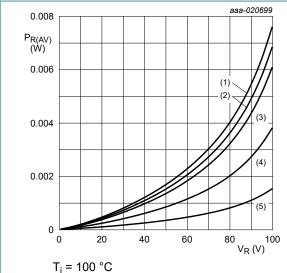


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



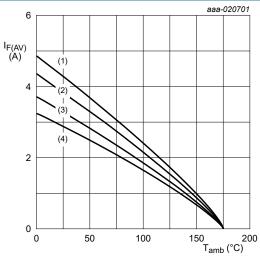
 $T_j = 100 \text{ °C}$   $(1) \delta = 0.1$   $(2) \delta = 0.2$   $(3) \delta = 0.5$   $(4) \delta = 0.8$  $(5) \delta = 1$ 

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $(1) \delta = 1$   $(2) \delta = 0.9$   $(3) \delta = 0.8$   $(4) \delta = 0.5$  $(5) \delta = 0.2$ 

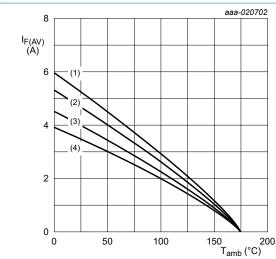
Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_j = 175 \,^{\circ}\text{C}$ (1)  $\delta = 1$ ; DC (2)  $\delta = 0.5$ ;  $f = 20 \,\text{kHz}$ (3)  $\delta = 0.2$ ;  $f = 20 \,\text{kHz}$ (4)  $\delta = 0.1$ ;  $f = 20 \,\text{kHz}$ 

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

 $T_i = 175 \,{}^{\circ}\text{C}$ 

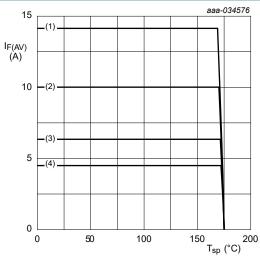
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

 $(4) \delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Ti = 175 °C

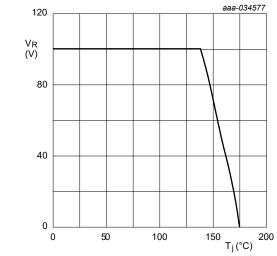
(1)  $\delta = 1$ ; DC

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

 $(4) \delta = 0.1$ ; f = 20 kHz

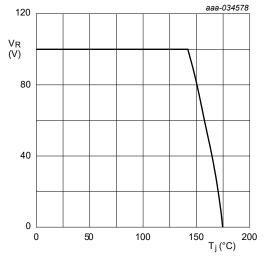
Fig. 10. Average forward current as a function of solder point temperature; typical values



FR4 PCB, standard footprint

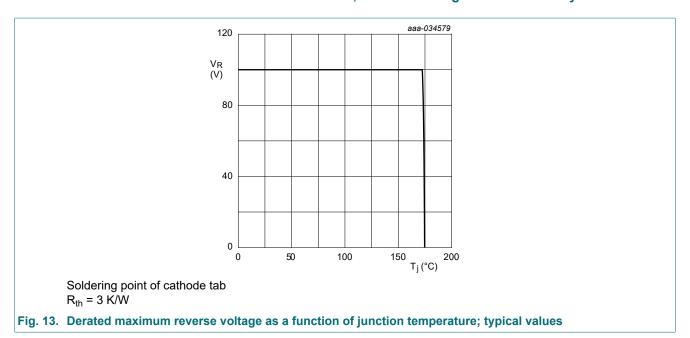
 $R_{th} = 90 \text{ K/W}$ 

of junction temperature; typical values

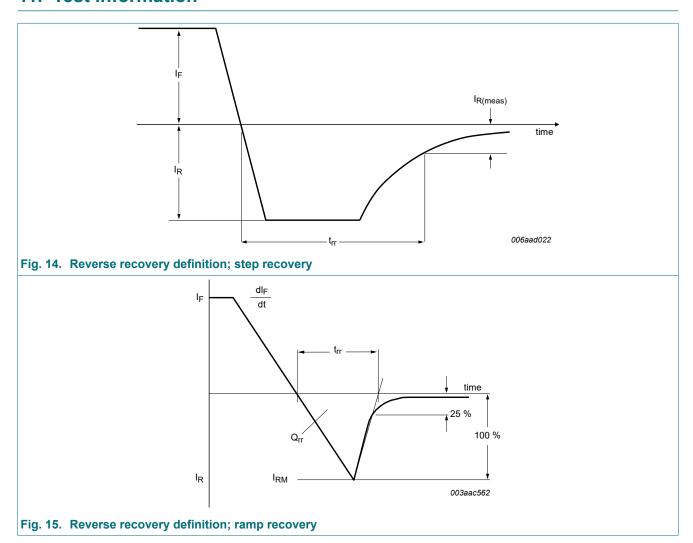


FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>  $R_{th} = 70 \text{ K/W}$ 

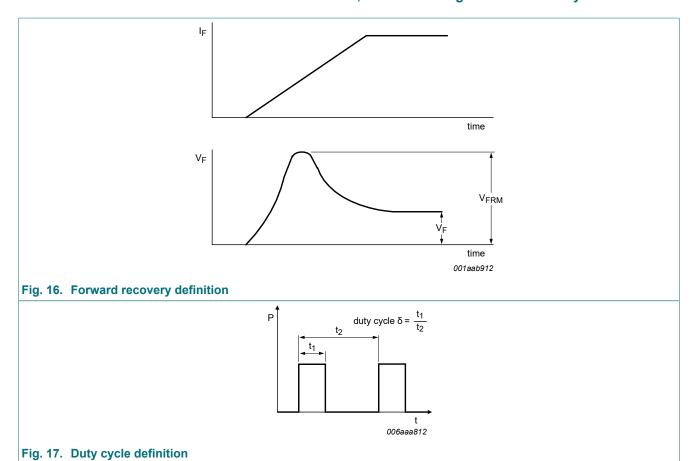
Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



### 11. Test information



7/12



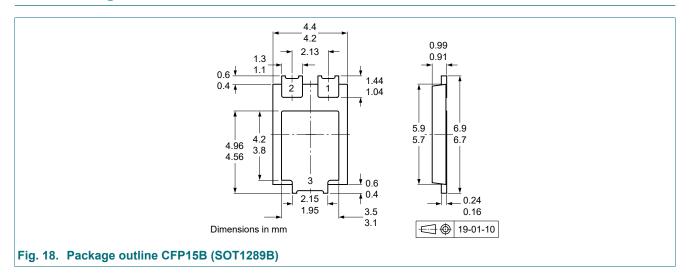
The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

 $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_{M} \times \sqrt{\delta}$ 

with  $I_{\mbox{\scriptsize RMS}}$  defined as RMS current.

# 12. Package outline



## 13. Soldering

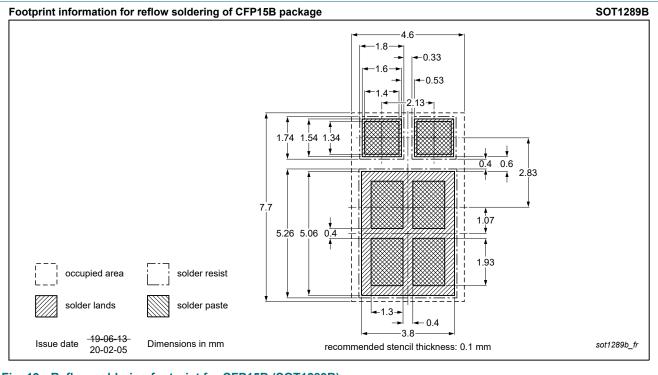


Fig. 19. Reflow soldering footprint for CFP15B (SOT1289B)

# 14. Revision history

### Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG100V100ELPE v.1	20220720	Product data sheet	-	-

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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